## **Application Data Sheet**

## Application information

09/008,497 Application number::

Utility Subject Matter::

2814 Suggested Group Art Unit::

CD-ROM or CD-R?:: None

Sequence submission?:: None

Computer Readable Form (CRF)?:: No

Title:: SEMICONDUCTOR DEVICE AND

METHOD FOR MANUFACTURING THE

SAME

21987-00033-US Attorney Docket Number::

Request for Early Publication?::

Request for Non-Publication?:: No

Total Drawing Sheets:: 8

Small Entity?:: No

Petition included?:: No

Secrecy Order in Parent Appl.?:: No

## Applicant Information

Applicant Authority Type:: Inventor

Primary Citizenship Country:: Japan

Status:: Full Capacity

Given Name:: Hiroyuki

Family Name:: Inoue

City of Residence:: Tokyo

Country of Residence::

Street of mailing address:: c/o Nippon Steel Corporation

6-3, Ohtemachi 2-chome

City of mailing address:: Tokyo

State or Province of mailing address:: Chiyoda-Ku

Japan

Correspondence Information

Correspondence Customer Number::

30678

Representative Information

Representative Customer Number::

30678

**Domestic Priority Information** 

Application::

Continuity Type::

Parent Application::

Parent Filing Date::

This Application

Division of

08/747,928

11/12/96

**Foreign Priority Information** 

Country::

Application number::

Filing Date::

Priority Claimed::

Japan

07-319482

11/14/95

Yes

**Assignee Information** 

Assignee name::

United Microelectronics Corporation

Street of mailing address::

No. 3, Li-Hsin Road

Science-Based Industrial Park

City of mailing address::

Hsin-Chu City

Country of mailing address::

Taiwan, Republic of China

Postal or Zip Code of mailing address::

30077

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